

## 900V 9A N-Channel Enhancement Mode Power MOSFET

### Description

The AKT9N90FB is an N-Channel enhancement mode power MOSFET which using proprietary planar stripe and DMOS technology.

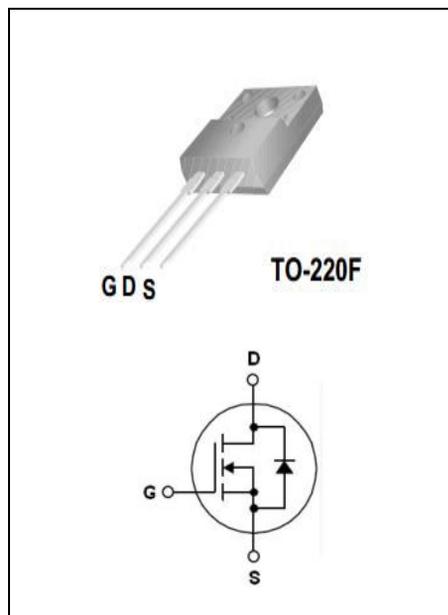
This MOSFET has low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for UPS,DC-DC converters and AC-DC power supply.

### Features

- Low on-Resistance:  $R_{DS(on)}=0.80\Omega(\text{typ.})$
- Special Process Technology for high ESD Capability
- 100% Avalanche Test
- Good Stability and Uniformity with High  $E_{AS}$

### Applications

- UPS Applications
- DC-DC Converters and AC-DC Power Supply



### Absolute Maximum Ratings @ $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter                               | Ratings                 | Unit             |                     |
|-----------|---|-------------------------|------------------|---------------------|
| $V_{DSS}$ | Drain to Source Voltage                 | 900                     | V                |                     |
| $V_{GSS}$ | Gate to Source Voltage                  | $\pm 30$                | V                |                     |
| $I_D$     | Drain Current                           | $T_c=25^\circ\text{C}$  | 9                | A                   |
|           |   | $T_c=100^\circ\text{C}$ | 5.8              | A                   |
| $I_{DM}$  | Pulsed Drain Current (Note1)            | 36                      | A                |                     |
| $P_D$     | Maximum Power Dissipation               | $T_c=25^\circ\text{C}$  | 69               | W                   |
|           | Derate above $25^\circ\text{C}$         |                         | 0.56             | W/ $^\circ\text{C}$ |
| $E_{AS}$  | Single Pulsed Avalanche Energy (Note 2) | 1240                    | mJ               |                     |
| $T_J$     | Operating Junction Temperature Range    | -55~+150                | $^\circ\text{C}$ |                     |
| $T_{STG}$ | Storage Temperature Range               | -55~+150                | $^\circ\text{C}$ |                     |

### Thermal Characteristics

| Symbol        | Parameter                               | Ratings | Unit                      |
|---------------|---|---------|---------------------------|
| $R_{th(J-C)}$ | Thermal Resistance, Junction to case    | 1.8     | $^\circ\text{C}/\text{W}$ |
| $R_{th(J-A)}$ | Thermal Resistance, Junction to Ambient | 40      | $^\circ\text{C}/\text{W}$ |

## Electrical Characteristics @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol       | Parameter                         | Conditions                    | Min. | Typ. | Max.      | Unit     |
|--------------|-----------------------------------|-------------------------------|------|------|-----------|----------|
| $BV_{DSS}$   | Drain to Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$     | 900  | -    | -         | V        |
| $V_{GS(th)}$ | Gate Threshold Voltage            | $V_{DS}=V_{GS}, I_D=250\mu A$ | 3.0  | 3.65 | 5         | V        |
| $R_{DS(on)}$ | Static Drain-Source On-Resistance | $V_{GS}=10V, I_D=4.5A$        | -    | 0.8  | -         | $\Omega$ |
| $I_{DSS}$    | Zero Gate Voltage Drain Current   | $V_{DS}=900V, V_{GS}=0V$      | -    | -    | 10        | $\mu A$  |
| $I_{GSS}$    | Gate to Source Leakage Current    | $V_{GS}=\pm 30V, V_{DS}=0V$   | -    | -    | $\pm 100$ | nA       |

## D-S Diode Characteristics and Maximum Rating @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol   | Parameter                                     | Conditions           | Min. | Typ. | Max. | Unit    |
|----------|---|----------------------|------|------|------|---------|
| $I_S$    | Maximum Drain to Source Diode Forward Current |                      | -    | -    | 9    | A       |
| $V_{SD}$ | Drain-Source Diode Forward Voltage            | $V_{GS}=0V, I_S=9A$  | -    | 0.84 | 1.0  | V       |
| $t_{rr}$ | Reverse Recovery Time                         | $V_{GS}=0V, I_S=9A,$ | -    | 0.5  | -    | us      |
| $Q_{rr}$ | Reverse Recovery Charge                       | $di/dt=-100A/us$     | -    | 6.4  | -    | $\mu C$ |

## Switching Characteristics @ $T_c=25\text{ }^\circ\text{C}$ unless otherwise noted

| Symbol       | Parameter                    | Conditions   | Min. | Typ. | Max. | Unit |
|--------------|------------------------------|--|------|------|------|------|
| $t_{d(on)}$  | Turn-on Delay Time           | $I_D=9A,$<br>$V_{DD}=450V,$<br>$R_G=25\Omega$ (Note 3) | -    | 50   | 105  | ns   |
| $t_r$        | Rising Time                  |  | -    | 115  | 245  | ns   |
| $t_{d(off)}$ | Turn-off Delay Time          |  | -    | 95   | 200  | ns   |
| $t_f$        | Falling Time                 |  | -    | 70   | 155  | ns   |
| $C_{iss}$    | Input Capacitance            | $V_{GS}=0V, V_{DS}=25V,$<br>$f=1.0MHz$                 | -    | -    | 2720 | pF   |
| $C_{oss}$    | Output Capacitance           |  | -    | -    | 220  | pF   |
| $C_{rss}$    | Reverse Transfer Capacitance |  | -    | -    | 18   | pF   |
| $Q_g$        | Total Gate Charge            | $I_D=9A,$<br>$V_{DS}=720V$<br>$V_{GS}=10V$ (Note 3)    | -    | 43   | -    | nC   |
| $Q_{gs}$     | Gate to Source Charge        |  | -    | 11   | -    | nC   |
| $Q_{gd}$     | Gate to Drain Charge         |  | -    | 16   | -    | nC   |

### Note:

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $L=5mH, V_{DD}=100V, V_G=10V, @T_c=25^\circ C$
3. Essentially independent of operating temperature typical characteristics

**Typical Performance Characteristics**

Fig. 1. Typical on-Region Characteristics

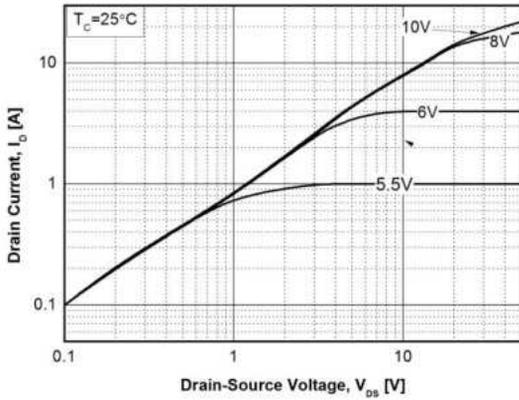


Fig. 2. Typical Transfer Characteristics

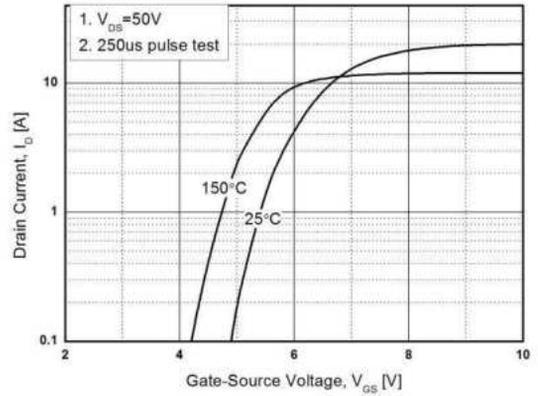


Fig. 3. Static on-Resistance vs.  $I_D$

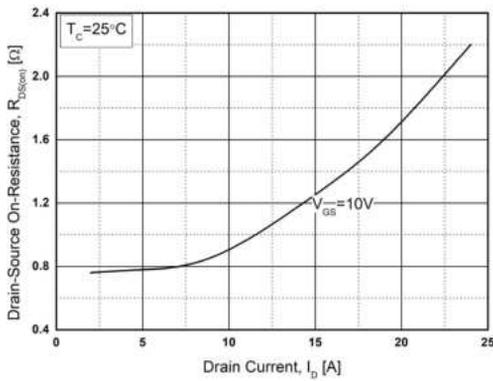


Fig. 4. Body Diode Forward Voltage vs.  $I_{DR}$

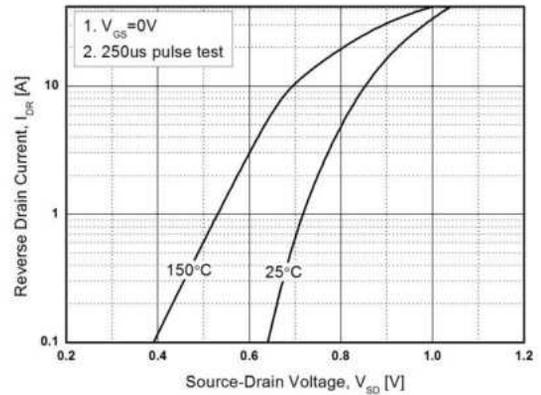


Fig. 5. Capacitance Characteristics

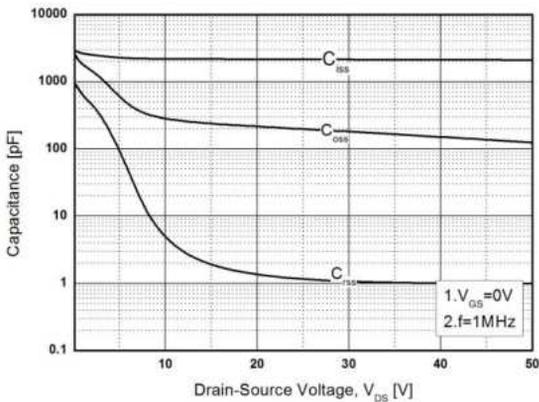
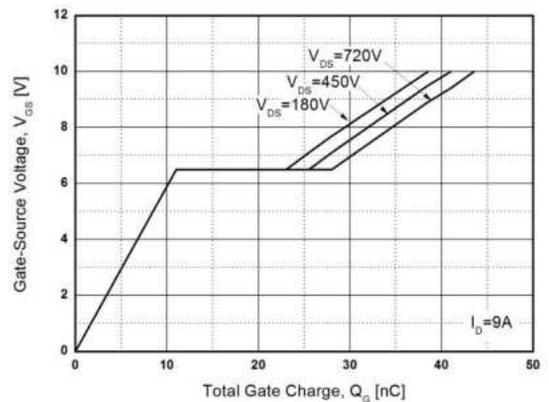


Fig. 6. Gate Charge Characteristics



**Typical Performance Characteristics**

Fig. 7. Breakdown Voltage vs. Temperature

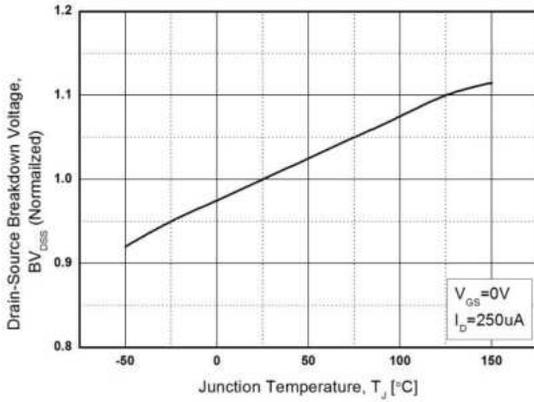


Fig. 8. Static on-Resistance vs. Temperature

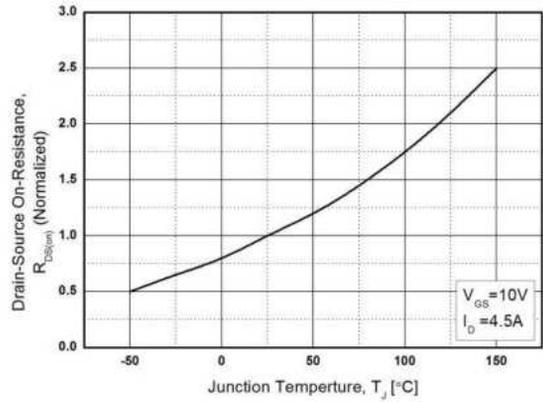


Fig. 9. Maximum Safe Operating Area

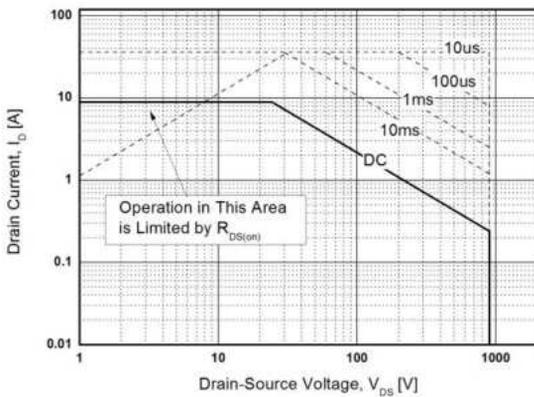


Fig. 10. Maximum Drain Current vs. Temperature

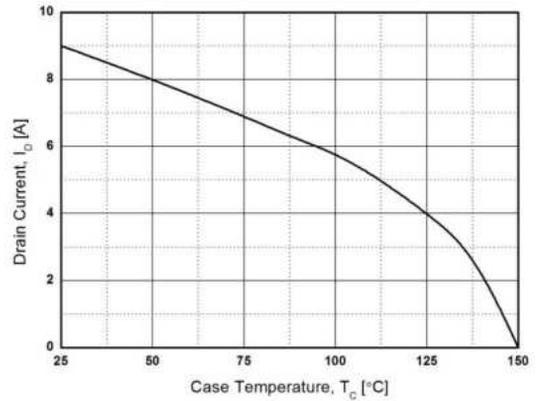
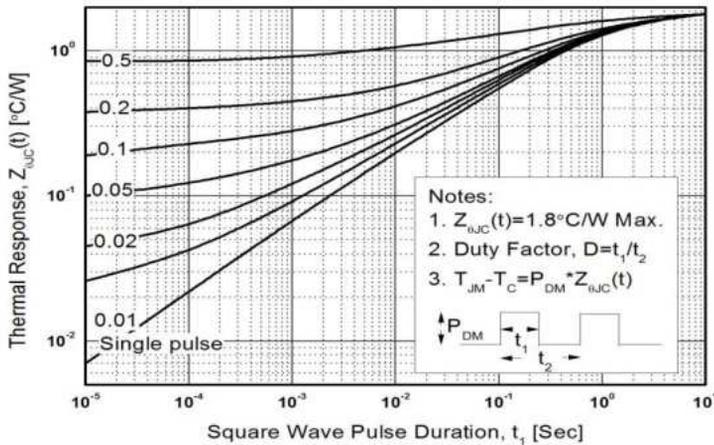


Fig. 11. Transient Thermal Response Curve



**Package Dimensions**

**TO-220F**

(Dimensions in Millimeters)

